ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International a	Composition Dec 2005. IPC, Bannockt and Pan-American co	claration ourn, Illinois. A opyright conver	All rights reserved u ntions.	nder both	This docume level parts, tl	ent is a declaration er	on of the substand acompasses all lo	es within the ma wer level materia	nufacturer liste als for which th	ed item. Note: ne manufacture	if the item is an as er has engineering	sembly with low responsibility.	
	1 IPC Web Site for Information on IPC-1752 Standard Form Ty			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				s Materials and	als and Mfg Information			
upplier Information													
ompany name*	Company unique ID			τ	Unique ID Authority				Response Date*				
nsemi									2023-06-08				
Contact Name 7			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			1	Phone - Representative*			Ema	Email - Representative*				
roduct-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Iten		n Number Mfr Item Name			Effective Date	Version	Manufacturing	g Site	Weight*	UOM	Unit Type	
	LC75814	LC75814VS-TLM-E LCD Display I		river		2023-06-08		РНМ		200.0	mg	Each	
Ianufacturing Proccess Info	ormation						-						
Terminal Plating / Grid Ar	Terminal Plating / Grid Array Material Ter		erminal Base Alloy J-STD-020 MSI		Rating	Peak Process Body Temperat		ature Max Time	at Peak Temp	erature Num	ber of Reflow Cyc	cles	
contains Bi		CU Alloy 4			260 C 30		30	se	seconds 3				
omments													
or more information regarding ma	aterial composition	please refer to	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select	the Level (IIG A IIG B	Requester or Supplier) [B	l select the subst	ance category (JIG or Requester) or enter a	value (Supplier) [C] selec	t the substance (II	G) or enter the substa	ace and CAS (Other) [D]
select a RoHS exemption, if applie	cable [E] enter the weigh	t of the substance or the P	PM concentration	[F] Optionally enter the positive (+) and ne	egative (-) tolerance in per	cent (Note: percer	t tolerance values are	expected to cover a 3
igma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.43	mg	Supplier	Silicon (Si)	7440-21-3		3.4087	mg
			Supplier	Polyimide	Proprietary Data		0.0213	mg
Die Attach	0.72	mg	Supplier	Silver (Ag)	7440-22-4		0.4899	mg
			Supplier	Epoxy resins	129915-35-1		0.2082	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0157	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0062	mg
Lead Frame	60.7	mg	Supplier	Silver (Ag)	7440-22-4		0.9651	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0728	mg
			Supplier	Iron (Fe)	7439-89-6		1.4022	mg
			Supplier	Copper (Cu)	7440-50-8		58.2113	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0486	mg
Mold Compound-Black	132.31	mg		Epoxy Phenol Resin	proprietary data		15.8772	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5292	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		111.9342	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		3.9693	mg
Plating	2.13	mg	В	Bismuth (Bi)	7440-69-9		0.0128	mg
			Supplier	Tin (Sn)	7440-31-5		2.1172	mg
Wire Bond - Au	0.71	mg	Supplier	Gold (Au)	7440-57-5		0.71	mg